☐ MN102H730F, MN102H73G, MN102H73K

Type		1			
туре	MN102H730F	MN102H73G (under development)	MN102H73K (under development)		
ROM (x8-bit)	External	128 K	256 K		
RAM (×8-bit)	10 K	10 K	12 K		
Package	TQFP128-P-1414B *Lead-free	TQFP128	8-P-1414A *Lead-free		
Minimum Instruction Execution Time	With main clock operated	With main clock operated 58 ns (at 3.0 V to 3.6 V, 34 MHz)			
Interrupts	• RST pin • Watchdog • NMI pin • Timer counter 0 to 9 underflow • Timer counter 10 to 14 underflow • Timer counter 10 to 14 compare capture A • Timer counter 10 to 14 compare capture B • ATC ch.0 to 1 transfer finish • ETC ch.0 to 1 transfer finish • External 0 to 7 • Serial ch.0 to 4 transmission • Serial ch.0 to 4 reception • A/D conversion finish				
Timer Counter	s	1/2 of system clock (BOSC) frequency; system clock (BOSC) underflow of timer counter 0	underflow of timer counter 8; TM0IO pin;		
	t	1/2 of system clock (BOSC) frequency; imer counter 0 output underflow of timer counter 1	underflow of timer counter 8; TM110 pin;		
	t	1/2 of system clock (BOSC) frequency; imer counter 1 output underflow of timer counter 2	underflow of timer counter 8; TM2IO pin;		
	Timer counter 3: 8-bit × 1 Clock source ······· 1		underflow of timer counter 8; TM3IO pin;		
		underflow of timer counter 3			
		1/2 of system clock (BOSC) frequency; system clock (BOSC)	underflow of timer counter 9; TM4IO pin;		
		anderflow of timer counter 4			
		1/2 of system clock (BOSC) frequency; imer counter 4 output	underflow of timer counter 9; TM5IO pin;		
	Interrupt source	underflow of timer counter 5			
		1/2 of system clock (BOSC) frequency; imer counter 5 output	underflow of timer counter 9; TM6IO pin;		
	Interrupt source ··················	underflow of timer counter 6			
	t	imer counter 6 output	underflow of timer counter 9; TM7IO pin;		
	•	anderflow of timer counter 7			
		1/2 of system clock (BOSC) frequency; 1/4 of system clock (XI) frequency; TM			
		underflow of timer counter 8			

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Timer Counter (Continue)	Timer counter 9: 8-bit \times 1				
(22.2.2.2.7)	Clock source				
	Interrupt source underflow of timer counter 9				
	Timer counter 10: 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input)				
	Clock source underflow of timer counter 8, 9; TM10IOB pin; 1/2 of system clock (BOSC)				
	frequency; 2-phase encode of TM10IOA pin/TM10IOB pin $(1 \times, 4 \times)$ Interrupt source underflow of timer counter 10; timer counter 10 compare capture A; timer counter 10 compare capture B				
	Timer counter 11 : 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input) Clock sourceunderflow of timer counter 8, 9; TM11IOB pin; 1/2 of system clock (BOSC) frequency; 2-phase encode of TM11IOA pin/TM11IOB pin (1 ×, 4 ×)				
	Interrupt source underflow of timer counter 11; timer counter 11 compare capture A; timer counter 11 compare capture B				
	Timer counter 12: 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input) Clock sourceunderflow of timer counter 8, 9; TM12IOB pin; 1/2 of system clock (BOSC) frequency; 2-phase encode of TM12IOA pin/TM12IOB pin (1 ×, 4 ×)				
	Interrupt sourceunderflow of timer counter 12; timer counter 12 compare capture A; timer counter 12 compare capture B				
	Timer counter 13: 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input) Clock sourceunderflow of timer counter 8, 9; TM13IOB pin; 1/2 of system clock (BOSC) frequency; 2-phase encode of TM13IOA pin/TM13IOB pin (1 ×, 4 ×)				
	Interrupt source underflow of timer counter 13; timer counter 13 compare capture A; timer counter 13 compare capture B				
	Timer counter 14: 16-bit × 1 (timer output, event count, input capture, PWM output, 2-phase encoder input) Clock source				
Serial Interface	Serial 0, 1:8-bit × 1 (transfer direction of MSB / LSB selectable, transmission / reception of 7, 8-bit length) Clock source				
	Serial 2, 3: 8-bit × 1 (transfer direction of MSB / LSB selectable, transmission / reception of 7, 8-bit length) Clock source				
	UART × 4 (common use with serial 0 to 3)				
	$I^2C \times 2$ (common use with serial 1,3; single master)				
Multiply-and-Accumulate	16-bit sign × 16-bit sign + 40-bit sign				
I/O Pins I/O	104 • Common use : 59 (use of full address, address data separate 16-bit mode) • Common use : 76 (use of address 16-bit, address data separate 8-bit mode)				
A/D Inputs					
D/A Outputs					
PWM	16-bit × 5-ch. (timer counter 10 to 14)				
ICR	16-bit × 5-ch. (timer counter 10 to 14)				
OCR	16-bit × 5-ch. (timer counter 10 to 14)				
Notes	Address / data separate bus interface; 8 / 16-bit bus width selectable; SRAM interface				
See the next page for electrical characteristics, pin assignment and suppor					

See the next page for electrical characteristics, pin assignment and support tool.

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Electrical Characteristics Supply current

Parameter	0	0 1111	Limit			
	Symbol	Condition		typ	max	Unit
Operating supply current	IDDopr	VI = VDD or VSS, output open	60+1		60+10α*	α* mA
	Проорг	f = 34 MHz , $VDD = 3.3 V$			00+10u.	
Supply current at STOP	IDDS	Pin with pull-up resistor is open			70	
	נטטו	all other input pins and Hi-Z state input/output		/0	μA	
Supply current at HALT	IDDII	pins are simultaneously applied VDD or VSS level			30+10α*	mA
Supply current at HALI	IDDH	f = 34 MHz, $VDD = 3.3 V$, output open		30+100."		

(Ta = -40°C to +85°C, VDD = AVDD = 3.3 V, VSS = AVSS = 0 V)

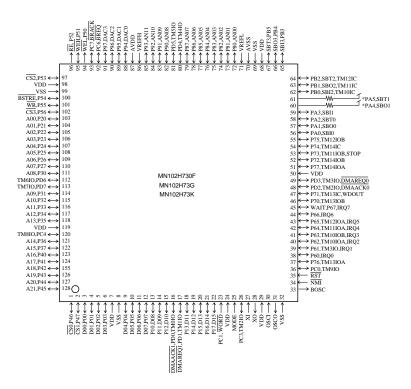
 \ast " α " depends on products .

 $MN102H73G/73K/730F\ \alpha=0$

MN102HF73G $\alpha = 1$

MN102HF73K $\alpha = 2$

Pin Assignment



TQFP128-P-1414A *Lead-free TQFP128-P-1414B *Lead-free * Use 4.7 k Ω to 10 k Ω .

Support Tool

I	In-circuit Emulator	PX-ICE102H73-128P1414		
I	Flash Memory Built-in Type	Туре	MN102HF73G, MN102HF73K	
		ROM (× 8-bit)	128 K / 256 K	
		RAM (× 8-bit)	10 K / 12 K	
		Minimum instruction execution time	58 ns (at 3.0 V to 3.6 V, 34 MHz)	
		Package	TQFP128-P-1414B *Lead-free	

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